

Technical Data
Data Sheet N1054, Rev. -

Green Products

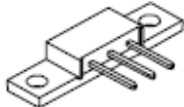
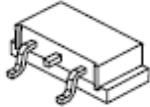
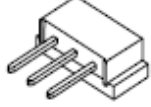
63CNQ080/63CNQ100 SCHOTTKY RECTIFIER

Applications:

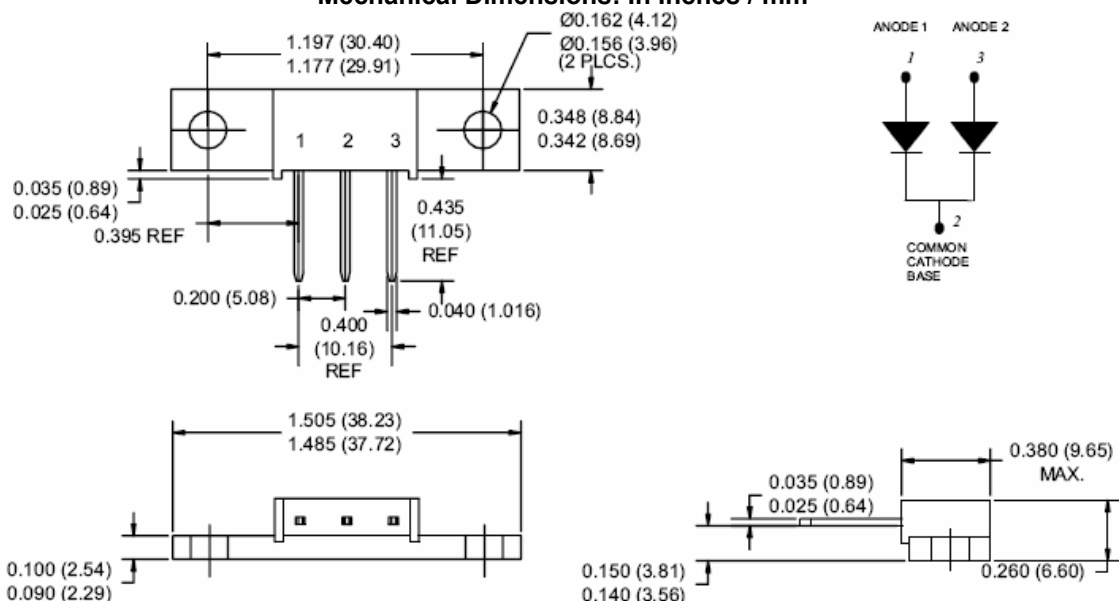
- Switching power supply
- Converters
- Free-Wheeling diodes
- Reverse battery protection

Features:

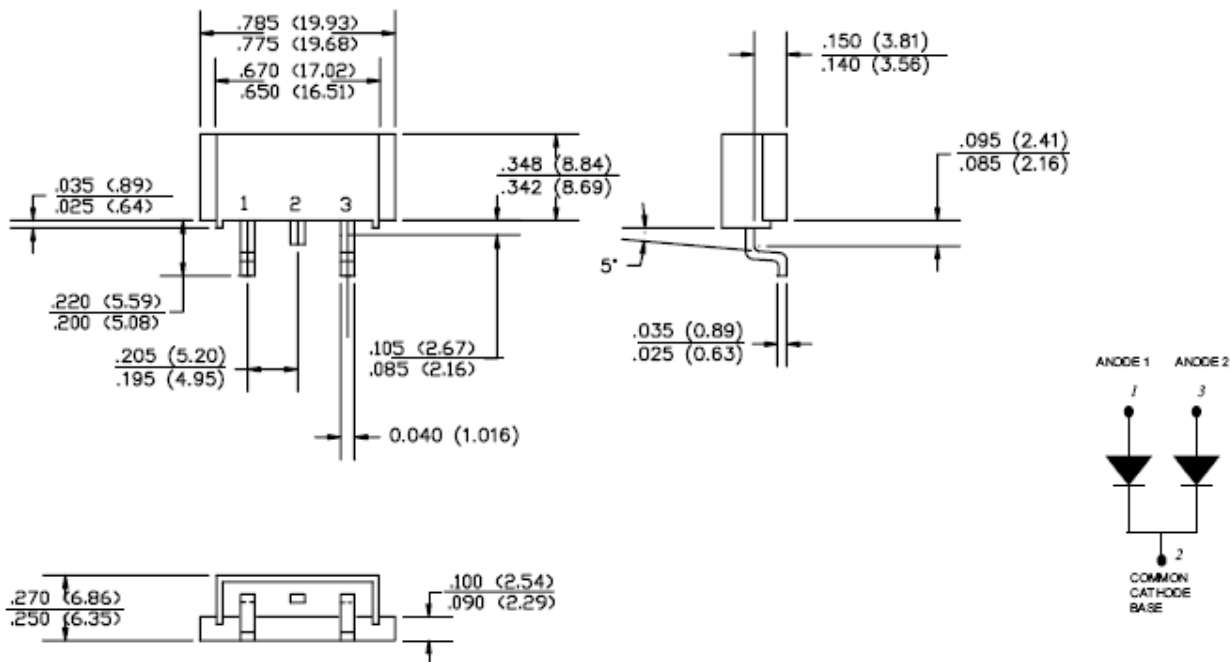
- 175°C T_J operation
- Center tap module
- Very Low forward voltage drop
- High purity, high temperature epoxy encapsulation for enhanced mechanical strength and moisture resistance
- High frequency operation
- Guard ring for enhanced ruggedness and long term reliability
- Low profile, high current package
- This is a Pb - Free Device
- All SMC parts are traceable to the wafer lot
- Additional testing can be offered upon request

Case Styles		
63CNQ...  PRM3	63CNQ...SL  PRM3-SL	63CNQ...SM  PRM3-SM

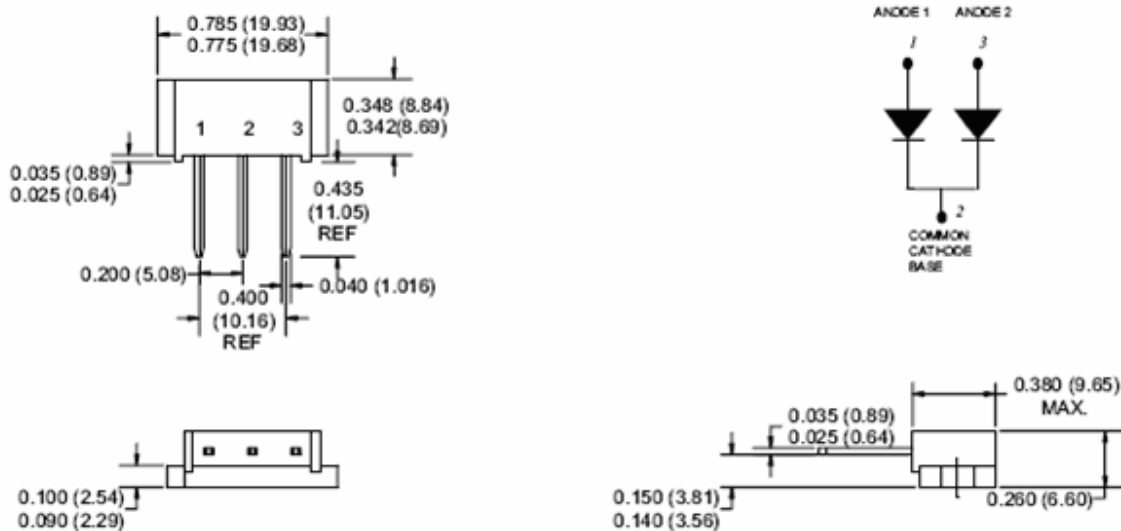
Mechanical Dimensions: In Inches / mm



PRM3



PRM3-SL



PRM3-SM

MARKING, MOLDING RESIN

Marking for 63CNQ080/SL/SM, 1st row SS YYWWL, 2nd row 63CNQ080/SL/SM, 3rd row 1 2 3 (pin)
Where YY is the manufacture year
WW is the manufacture week code
L is the wafer's Lot Number

Molding resin
Epoxy resin UL: 94V-0

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Maximum Ratings:

Characteristics	Symbol	Condition	Max.	Units
Peak Inverse Voltage	V_{RWM}	-	80(63CNQ080) 100(63CNQ100)	V
Max. Average Forward	$I_{F(AV)}$	50% duty cycle @ $T_C = 155^\circ\text{C}$, rectangular wave form	60	A
Max. Peak One Cycle Non-Repetitive Surge Current (per leg)	I_{FSM}	8.3 ms, half Sine pulse	750	A
Non-Repetitive Avalanche Energy(per leg)	E_{AS}	$T_J = 25^\circ\text{C}, I_{AS} = 1\text{A}, L = 30\text{mH}$	15	mJ
Repetitive Avalanche Current(per leg)	I_{AR}	Current decaying linearly to zero in 1 μsec Frequency limited by T_J max. $V_A = 1.5 \times V_R$ typical	1	A

Electrical Characteristics:

Characteristics	Symbol	Condition	Max.	Units
Max. Forward Voltage Drop (per leg) *	V_{F1}	@ 30A, Pulse, $T_J = 25^\circ\text{C}$ @ 60A, Pulse, $T_J = 25^\circ\text{C}$	0.80 0.93	V
	V_{F2}	@ 30A, Pulse, $T_J = 125^\circ\text{C}$ @ 60A, Pulse, $T_J = 125^\circ\text{C}$	0.64 0.76	V
Max. Reverse Current (per leg) *	I_{R1}	@ $V_R = \text{rated } V_R, T_J = 25^\circ\text{C}$	1.5	mA
	I_{R2}	@ $V_R = \text{rated } V_R, T_J = 125^\circ\text{C}$	20	mA
Max. Junction Capacitance (per leg)	C_T	@ $V_R = 5\text{V}, T_C = 25^\circ\text{C}$ $f_{SIG} = 1\text{MHz}$	1400	pF
Typical Series Inductance (per leg)	L_S	Measured lead to lead 5 mm from package body	6.0	nH
Max. Voltage Rate of Change	dv/dt	-	10,000	V/ μs

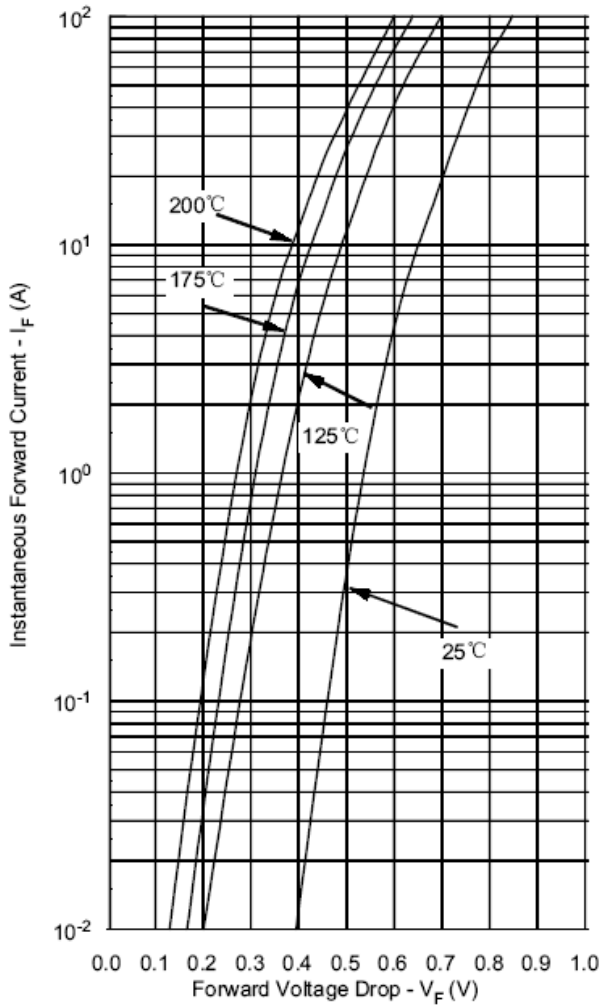
* Pulse Width < 300 μs , Duty Cycle <2%

Thermal-Mechanical Specifications:

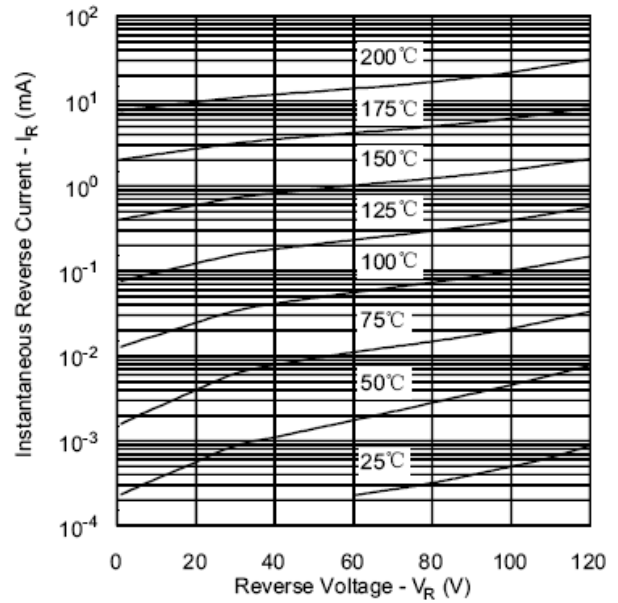
Characteristics	Symbol	Condition	Specification	Units
Max. Junction Temperature	T_J	-	-55 to +175	$^\circ\text{C}$
Max. Storage Temperature	T_{stg}	-	-55 to +175	$^\circ\text{C}$
Maximum Thermal Resistance Junction to Case (per leg)	$R_{\theta JC}$	DC operation	0.85	$^\circ\text{C/W}$
Maximum Thermal Resistance Junction to Case (per package)	$R_{\theta JC}$	DC operation	0.42	$^\circ\text{C/W}$
Typical Thermal Resistance, case to Heat Sink	$R_{\theta cs}$	Mounting surface, smooth and greased	0.30	$^\circ\text{C/W}$
Mounting Torque	T_M	-	40(min)	Kg-cm
			58(max)	
Approximate Weight	wt	-	7.8	g
Case Style	PRM3 PRM3-SL PRM3-SM			

• Weiqi Street, Airport Development Zone, Jiangning District, Nanjing, China 211113 ☎ (86) 25-87123907 •
 • FAX (86) 25-87123900 • World Wide Web Site - <http://www.sangdest.com.cn> • E-Mail Address - sales@sangdest.com.cn •

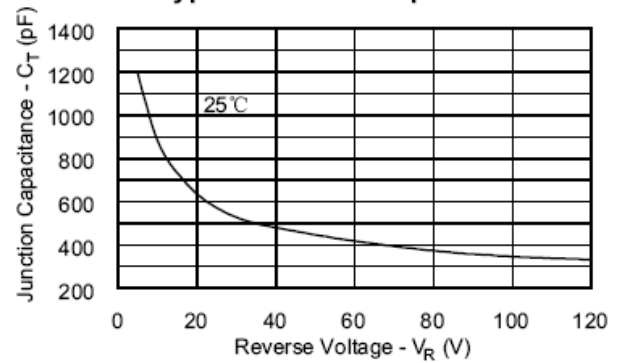
Typical Forward Characteristics



Typical Reverse Characteristics



Typical Junction Capacitance



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